

CHIPQUIK®

Sn42/Bi57.6/Ag0.4 .047" Solid Core Solder Wire 8oz Spool

Product Highlights LOW TEMPERATURE Melts at 138°C (281°F) Lead-Free RoHS III and REACH compliant

Specifications

Alloy: Wire diameter: Melting Point: Packaging: Sn42/Bi57.6/Ag0.4 0.047" (1.2mm) 138°C (281°F) 8oz Spool



Yes

SMD2SWLT.047 80Z

Storage and Handling Store in a non-corrosive, dry environment.

Please Note: Although Sn42/Bi57.6/Ag0.4 forms strong joints and is more ductile due to the added 0.4% Silver, in wire form it is brittle and needs to be handled gently when unspooling. It is normal for spooled Sn42/Bi57.6/Ag0.4 wire to have some breaks in it.

Test Results

| Test Requirement | Result |
|---|--|
| Electronic Industry Citizenship Coalition (EICC) | Compliant |
| Articles 33 and 67 of Regulation (EC) No 1907/2006 | Contains no substance >0.1% w/w that is listed as a SVHC or restricted for use in solder materials |
| | Electronic Industry Citizenship Coalition (EICC) Articles 33 and 67 of Regulation (EC) |

RoHS 3 Directive (EU) 2015/863:

Mouser Electronics

Authorized Distributor

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